## $\square$ MN103S83D


$\left(\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{VDD}=5.0 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}\right)$

## Pin Assignment



QFP084-P-1818E *Lead-free


LQFP080-P-1414A *Lead-free (under development)

## Support Tool

| In-circuit Emulator | PX-ICE-103S65 |  |
| :---: | :---: | :---: |
| Flash Memory Built-in Type | Type | MN103SF65GBF, MN103SF65GAL |
|  | ROM | 128K-byte |
|  | RAM | 4K-byte |
|  | Minimum instruction execution time | 25 ns (at 4.3 V to $5.5 \mathrm{~V}, 10 \mathrm{MHz}$ internal regulator used) |
|  |  | 25 ns (at 3.0 V to $3.6 \mathrm{~V}, 10 \mathrm{MHz}$ ) |
|  | Package | QFP084-P-1818I *Lead-free, LQFP080-P-1414B *Lead-free |

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